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Information

- Greetings
- Conference Topics

Paper Submission

Workshops and Short Courses

Special / Focused Sessions

APMC Prize and APMC Student Prize

Young Industrial Engineer Award

Student Design Competitions

APMC 2022 Registration Fee Support Program

IEICE Transactions on Electronics Special Issue

General Information

- Venue
- APMC 2022 Committee Officers
- Related Links

APMC 2022 Secretariat

Important Dates

- Registration Fee Support Program Deadline ... Jul. 8, 2022 [Hawaii time]
- Paper Submission Deadline ... Jul. 1st, 2022
- Notification of Acceptance ... Aug. 31, 2022
- Final Manuscript Submission Deadline ... Sept. 21, 2022

Final Call for Papers (PDF)

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Update

2022.07.01 Paper Submission Guidelines

"Paper Submission Guidelines" page was updated ... [more](#)

2022.07.01 Support Program Extension

"APMC 2022 Registration Fee Support Program" page was updated ... [more](#)

2022.06.17 Support Program Extension

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